

# INFORMATION DISCLOSURE STATEMENT LIST

(Use as many sheets as necessary)

Complete if Known

Application Number	10/711,682
Filing Date	September 30, 2004
First Named Inventor	CHAU
Group Art Unit	1793
Examiner Name	Hoban, Matthew E.

## U.S. PATENT DOCUMENTS

Examiner's Initials	Cite No.	Document No.	Date	Name	Class	Subclass	Filing Date (if appropriate)
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/M.H./	A2.	7,452,483	11/18/2008	Belinski-Wolfe <i>et al.</i>	252	301.4 S	8/3/2006
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/M.H./	A5.	2004/0227705	11/18/2004	Fujimoto <i>et al.</i>	345	76	2/12/2004
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## FOREIGN PATENT DOCUMENTS

Examiner's Initials	Cite No.	Foreign Patent Document Country Code-Number-Kind Code	Date	Name	Translation Yes No
/M.H./	A7.	EP 1 433 831 A	6/30/2004	Hiroto <i>et al.</i>	x
	A8.	EP 1 104 799 A	6/6/2001	Hintzen <i>et al.</i>	x
	A9.	EP 1 447 854 A	8/18/2004	Fujimoto <i>et al.</i>	x
	A10.	EP 1 371 711 A2	12/17/2003	Fan <i>et al.</i>	x
	A11.	EP 1 001 660	5/17/2000	Park	x
	A12.	JP 2005 146190 A	6/9/2005	Yano <i>et al.</i>	x
	A13.	JP 2001/302691	12/1989	Ito	Abstract only
	A14.	KR 849786	7/25/2008	Belinski-Wolfe <i>et al.</i>	x
	A15.	WO 2005/029596	3/31/2005	Takashima <i>et al.</i>	x
	A16.	WO 2000/33390	6/8/2000	Srivastava <i>et al.</i>	x
/M.H./	A17.	WO 2002/11173	2/7/2002	Danielson <i>et al.</i>	x

## NON-PATENT DOCUMENTS

Examiner's Initials	Cite No.	Non-Patent Citations (include Author, Title, Publisher, Relevant Pages, Date and Place of Publication)
/M.H./	A18.	Tanaka <i>et al.</i> "Electroluminescence Materials", Chapter 9, Section 2, Phosphor 1-24 Handbook, pages 601-612.

Examiner Signature: /Matthew Hoban/

Date Considered: 09/11/2010

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.